Claims

1. A sealable resin sheet for sealing an element, the sealable resin sheet containing thermosetting resin, a layered silicate compound and an inorganic filler other than the layered silicate compound,

wherein an upper limit of a content ratio of the thermosetting resin in the sealable resin sheet is 25 mass%,

wherein a lower limit of a content ratio of the layered silicate compound in the sealable resin sheet is 1 mass% and an upper limit of the content ratio of the layered silicate compound in the sealable resin sheet is 6 mass%, and

wherein a lower limit of a content ratio of the inorganic filler other than the layered silicate compound in the sealable resin sheet is 50 mass% and an upper limit of the content ratio of the inorganic filler other than the layered silicate compound in the sealable resin sheet is 90 mass%.

2. The sealable resin sheet according to Claim 1, wherein the layered silicate compound is smectite.

3. The sealable resin sheet according to Claim 1, wherein the layered silicate compound has a surface modified by an organic component.

4. The sealable resin sheet according to Claim 2, wherein the layered silicate compound has a surface modified by an organic component.

5. The sealable resin sheet according to Claim 1, wherein a lower limit of the content ratio of the layered silicate compound is 3 mass% or more.

6. The sealable resin sheet according to Claim 2, wherein a lower limit of the content ratio of the layered silicate compound is 3 mass% or more.

7. The sealable resin sheet according to Claim 3, wherein a lower limit of the content ratio of the layered silicate compound is 3 mass% or more.

8. The sealable resin sheet according to Claim 4, wherein a lower limit of the content ratio of the layered silicate compound is 3 mass% or more.